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MAX30102

High-Sensitivity Pulse Oximeter and Heart-Rate Sensor for Wearable Health

General Description

The MAX30102 is an integrated pulse oximetry and heart-rate monitor module. It includes internal LEDs, photodetectors, optical elements, and low-noise electronics with ambient light rejection. The MAX30102 provides a complete system solution to ease the design-in process for mobile and wearable devices.

The MAX30102 operates on a single 1.8V power supply and a separate 5.0V power supply for the internal LEDs. Communication is through a standard I²C-compatible interface. The module can be shut down through software with zero standby current, allowing the power rails to remain powered at all times.

Applications

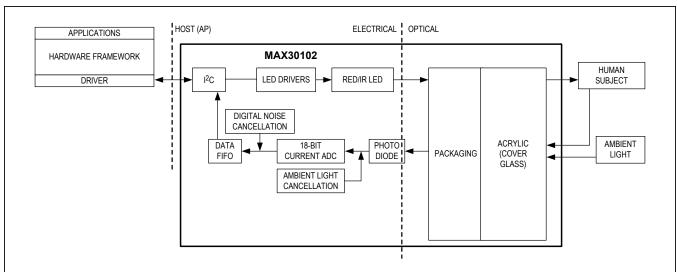
- Wearable Devices
- Fitness Assistant Devices

Benefits and Features

- Heart-Rate Monitor and Pulse Oximeter Sensor in LED Reflective Solution
- Tiny 5.6mm x 3.3mm x 1.55mm 14-Pin Optical Module
 - Integrated Cover Glass for Optimal, Robust Performance
- Ultra-Low Power Operation for Mobile Devices
 - Programmable Sample Rate and LED Current for Power Savings
 - Low-Power Heart-Rate Monitor (< 1mW)
 - Ultra-Low Shutdown Current (0.7µA, typ)
- Fast Data Output Capability
 - · High Sample Rates
- Robust Motion Artifact Resilience
 - · High SNR
- -40°C to +85°C Operating Temperature Range

Ordering Information appears at end of data sheet.

System Diagram





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Absolute Maximum Ratings

V _{DD} to GND	0.3V to +2.2V
GND to PGND	0.3V to +0.3V
X_DRV, V _{LED+} to PGND	0.3V to +6.0V
All Other Pins to GND	0.3V to +6.0V
Output Short-Circuit Current Duration	Continuous
Continuous Input Current into Any Terminal .	±20mA
ESD, Human Body Model (HBM)	2.5kV
Latchup Immunity	±250mA

Continuous Power Dissipation ($T_A = +70^{\circ}C$)	
OESIP (derate 5.5mW/°C above +70°C)	440mW
Operating Temperature Range	40°C to +85°C
Junction Temperature	+90°C
Soldering Temperature (reflow)	+260°C
Storage Temperature Range	-40°C to +105°C

Package Thermal Characteristics (Note 1)

OESIP

Junction-to-Ambient Thermal Resistance (θ_{JA}).......180°C/W Junction-to-Case Thermal Resistance (θ_{JC}).......150°C/W

Note 1: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maximintegrated.com/thermal-tutorial.

Electrical Characteristics

 $(V_{DD}$ = 1.8V, V_{IR_LED+} = V_{R_LED+} = 5.0V, V_{A} = -40°C to +85°C, unless otherwise noted. Typical values are at V_{A} = +25°C) (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
POWER SUPPLY						
Power-Supply Voltage	V _{DD}	Guaranteed by RED and IR count tolerance	1.7	1.8	2.0	V
LED Supply Voltage R_LED+ or IR_LED+ to PGND	V _{LED+}	Guaranteed by PSRR of LED driver (R_LED+ and IR_LED+ only)	3.1	3.3	5.25	V
Supply Current	I _{DD}	SpO ₂ and HR mode, PW = 215µs, 50sps		600	1200	μA
		IR only mode, PW = 215µS, 50sps		600	1200	
Supply Current in Shutdown	I _{SHDN}	$T_A = +25^{\circ}C$, MODE = 0x80		0.7	10	μA
PULSE OXIMETRY/HEART-RATI	E SENSOR CH	IARACTERISTICS				
ADC Resolution				18		bits
Red ADC Count (Note 3)	REDC	RED_PA = 0x0C, LED_PW = 0x01, SPO2_SR = 0x05, ADC_RGE = 0x00, T _A = +25°C	55536	65536	75536	Counts
IR ADC Count (Note 3)	IRC	IR_PA = 0x0C, LED_PW = 0x01, SPO2_SR = 0x05 ADC_RGE = 0x00, T _A = +25°C	55536	65536	75536	Counts

Electrical Characteristics (continued)

 $(V_{DD}$ = 1.8V, V_{IR_LED+} = V_{R_LED+} = 5.0V, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at T_A = +25°C) (Note 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
		RED_PA = IR_PA = 0x00,		30	128	Counts	
Dark Current Count	LED_DCC	LED_PW = 0x03, SPO2_SR = ADC_RGE = 0x02	= 0x01		0.01	0.05	% of FS
DC Ambient Light Rejection	ALR	ADC counts with finger on sensor under direct sunlight (100K lux), ADC_RGE		2		Counts	
		= 0x3, LED_PW = 0x03, SPO2_SR = 0x01		2		Counts	
ADC Count—PSRR (V _{DD})	PSRRV _{DD}	1.7V < V _{DD} < 2.0V, LED_PW = 0x00, SPO2_SR = T _A = +25°C	= 0x05		0.25	1	% of FS
		Frequency = DC to 100kHz, 10	00mV _{P-P}		10		LSB
ADC Count—PSRR	PSRR _{LED}	3.6V < R_LED+, IR_LED+ < 5 T _A = +25°C	5.0V,		0.05	1	% of FS
(LED Driver Outputs)		Frequency = DC to 100kHz, 10	00mV _{P-P}		10		LSB
ADC Clock Frequency	CLK			10.32	10.48	10.64	MHz
		LED_PW = 0x00			69		
ADC Integration Time	INT	LED_PW = 0x01			118		μs
ADO Integration Time		LED_PW = 0x02			215		μδ
		LED_PW = 0x03		411			
Slot Timing (Timing Between		LED_PW = 0x00			427.1		
Sequential Channel Samples;	INT	LED_PW = 0x01			524.7		μs
e.g., Red Pulse Rising Edge To IR Pulse Rising Edge)		LED_PW = 0x02			720.0		μο
IK Fulse Kising Euge)		LED_PW = 0x03					
COVER GLASS CHARACTERIS	TICS (Note 4)	T					T
Hydrolytic Resistance Class		Per DIN ISO 719			HGB 1		
IR LED CHARACTERISTICS (No	ote 4)	1					1
LED Peak Wavelength	λР	$I_{LED} = 20 \text{mA}, T_A = +25 ^{\circ}\text{C}$		870	880	900	nm
Full Width at Half Max	Δλ	I_{LED} = 20mA, T_A = +25°C			30		nm
Forward Voltage	V _F	I _{LED} = 20mA, T _A = +25°C			1.4		V
Radiant Power	PO	I _{LED} = 20mA, T _A = +25°C			6.5		mW
RED LED CHARACTERISTICS (Note 4)						
LED Peak Wavelength	λ _P	I _{LED} = 20mA, T _A = +25°C		650	660	670	nm
Full Width at Half Max	Δλ	I _{LED} = 20mA, T _A = +25°C			20		nm
Forward Voltage	V _F	I _{LED} = 20mA, T _A = +25°C			2.1		V
Radiant Power	Po	I _{LED} = 20mA, T _A = +25°C			9.8		mW

Electrical Characteristics (continued)

 $(V_{DD}$ = 1.8V, V_{IR_LED+} = V_{R_LED+} = 5.0V, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at T_A = +25°C) (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
PHOTODETECTOR CHARACTE	RISTICS (Note	e 4)	1			
Spectral Range of Sensitivity	λ (QE > 50%)	QE: Quantum Efficiency	600		900	nm
Radiant Sensitive Area	А			1.36		mm ²
Dimensions of Radiant Sensitive Area	LxW			1.38 x 0.98		mm x mm
INTERNAL DIE TEMPERATURE	SENSOR					
Temperature ADC Acquisition Time	T _T	T _A = +25°C		29		ms
Temperature Sensor Accuracy	T _A	T _A = +25°C		±1		°C
Temperature Sensor Minimum Range	T _{MIN}			-40		°C
Temperature Sensor Maximum Range	T _{MAX}			85		°C
DIGITAL INPUT CHARACTERIS	TICS: SCL, SD	A				
Input High Voltage	V _{IH}	V _{DD} = 2V	0.7 x V _{DD}			V
Input Low Voltage	V _{IL}	V _{DD} = 2V			0.3 x V _{DD}	V
Hysteresis Voltage	V _H			0.2		V
Input Leakage Current	I _{IN}	V _{IN} = GND or V _{DD} (STATIC)		±0.05	±1	μΑ
DIGITAL OUTPUT CHARACTER	ISTICS: SDA,	INT				,
Ouput Low Voltage	V _{OL}	I _{SINK} = 6mA			0.2	V
I ² C TIMING CHARACTERISTICS	S (SDA, SDA, Ī	NT) (Note 4)	I			
I ² C Write Address				AE		Hex
I ² C Read Address				AF		Hex
Serial Clock Frequency	f _{SCL}		0		400	kHz
Bus Free Time Between STOP and START Conditions	t _{BUF}		1.3			μs
Hold Time (Repeated) START Condition	t _{HD;STA}		0.6			μs
SCL Pulse-Width Low	t _{LOW}		1.3			μs
SCL Pulse-Width High	tHIGH		0.6			μs
Setup Time for a Repeated START Condition	tsu;sta		0.6			μs
Data Hold Time	t _{HD;DAT}		0		900	ns

Electrical Characteristics (continued)

 $(V_{DD}$ = 1.8V, V_{IR} LED+ = V_{R} LED+ = 5.0V, T_{A} = -40°C to +85°C, unless otherwise noted. Typical values are at T_{A} = +25°C) (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Data Setup Time	t _{SU;DAT}		100			ns
Setup Time for STOP Condition	t _{SU;STO}		0.6			μs
Pulse Width of Suppressed Spike	t _{SP}		0		50	ns
Bus Capacitance	C _B				400	pF
SDA and SCL Receiving Rise Time	t _R		20 + 0.10	В	300	ns
SDA and SCL Receiving Fall Time	t _{RF}		20 + 0.10	В	300	ns
SDA Transmitting Fall Time	t _{TF}				300	ns

- **Note 2:** All devices are 100% production tested at $T_A = +25$ °C. Specifications over temperature limits are guaranteed by Maxim Integrated's bench or proprietary automated test equipment (ATE) characterization.
- **Note 3:** Specifications are guaranteed by Maxim Integrated's bench characterization and by 100% production test using proprietary ATE setup and conditions.
- Note 4: Guaranteed by design and characterization. Not tested in final production.

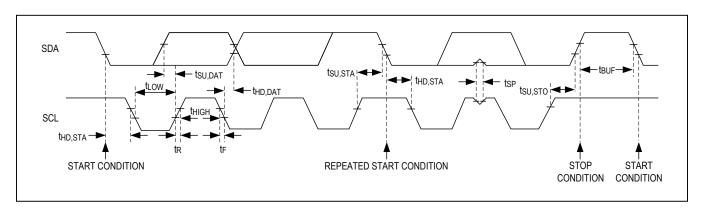
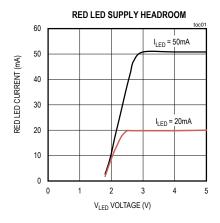
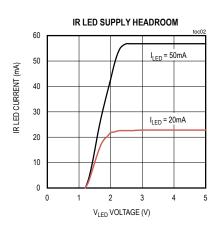


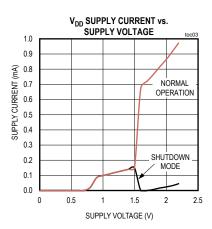
Figure 1. I²C-Compatible Interface Timing Diagram

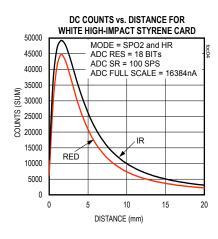
Typical Operating Characteristics

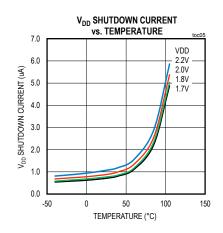
(V_{DD} = 1.8V, V_{LED+} = 5.0V, T_A = +25°C, \overline{RST} , unless otherwise noted.)

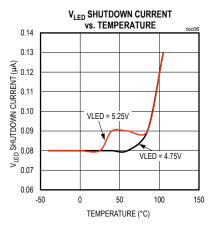


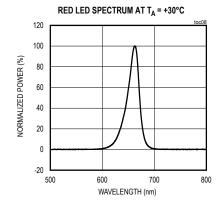


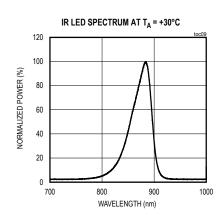






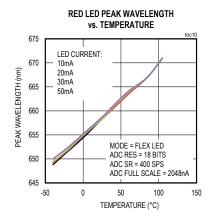


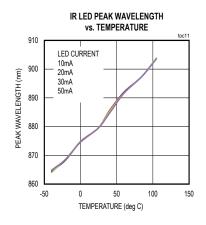


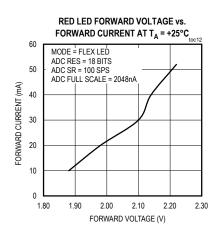


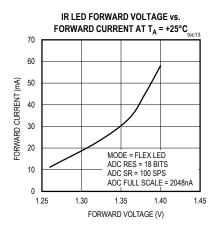
Typical Operating Characteristics (continued)

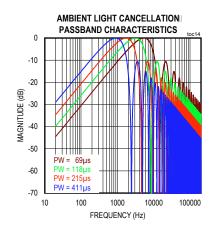
(V_{DD} = 1.8V, V_{LED+} = 5.0V, T_A = +25°C, \overline{RST} , unless otherwise noted.)

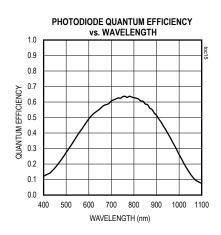




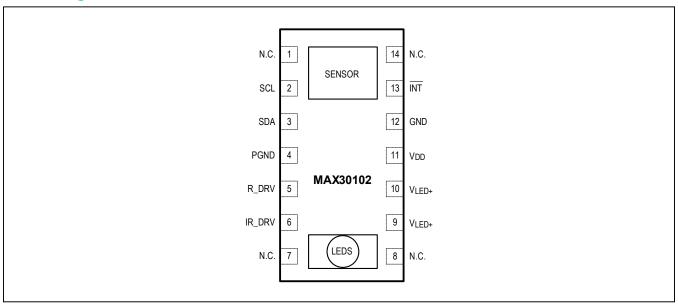








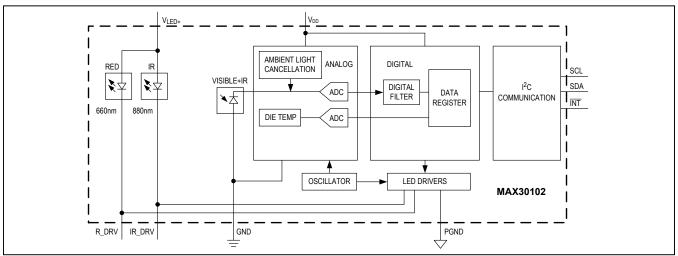
Pin Configuration



Pin Description

PIN	NAME	FUNCTION
1, 7, 8, 14	N.C.	No Connection. Connect to PCB pad for mechanical stability.
2	SCL	I ² C Clock Input
3	SDA	I ² C Data, Bidirectional (Open-Drain)
4	PGND	Power Ground of the LED Driver Blocks
5	R_DRV	Red LED Driver.
6	IR_DRV	IR LED Driver.
9	V _{LED+}	LED Power Supply (anode connection). Use a bypass capacitor to PGND for best
10	V _{LED+}	performance.
11	V _{DD}	Analog Power Supply Input. Use a bypass capacitor to GND for best performance.
12	GND	Analog Ground
13	ĪNT	Active-Low Interrupt (Open-Drain). Connect to an external voltage with a pullup resistor.

Functional Diagram



Detailed Description

The MAX30102 is a complete pulse oximetry and heart-rate sensor system solution module designed for the demanding requirements of wearable devices. The device maintains a very small solution size without sacrificing optical or electrical performance. Minimal external hardware components are required for integration into a wearable system.

The MAX30102 is fully adjustable through software registers, and the digital output data can be stored in a 32-deep FIFO within the IC. The FIFO allows the MAX30102 to be connected to a microcontroller or processor on a shared bus, where the data is not being read continuously from the MAX30102's registers.

SpO₂ Subsystem

The SpO $_2$ subsystem of the MAX30102 contains ambient light cancellation (ALC), a continuous-time sigma-delta ADC, and a proprietary discrete time filter. The ALC has an internal Track/Hold circuit to cancel ambient light and increase the effective dynamic range. The SpO $_2$ ADC has programmable full-scale ranges from 2 μ A to 16 μ A. The ALC can cancel up to 200 μ A of ambient current.

The internal ADC is a continuous time oversampling sigma-delta converter with 18-bit resolution. The ADC sampling rate is 10.24MHz. The ADC output data rate can be programmed from 50sps (samples per second) to 3200sps.

Temperature Sensor

The MAX30102 has an on-chip temperature sensor for calibrating the temperature dependence of the SpO_2 subsystem. The temperature sensor has an inherent resolution of $0.0625^{\circ}C$.

The device output data is relatively insensitive to the wavelength of the IR LED, where the Red LED's wavelength is critical to correct interpretation of the data. An SpO_2 algorithm used with the MAX30102 output signal can compensate for the associated SpO_2 error with ambient temperature changes.

LED Driver

The MAX30102 integrates Red and IR LED drivers to modulate LED pulses for SpO_2 and HR measurements. The LED current can be programmed from 0 to 50mA with proper supply voltage. The LED pulse width can be programmed from $69\mu s$ to $411\mu s$ to allow the algorithm to optimize SpO_2 and HR accuracy and power consumption based on use cases.

Proximity Function

The device includes a proximity function to save power and reduce visible light emission when the user's finger is not on the sensor. When the SpO₂ or HR function is initiated (by writing the MODE register), the IR LED is activated in proximity mode with a drive current set by the PILOT_PA register. When an object is detected by exceeding the IR ADC count threshold (set in the PROX_INT_THRESH register), the part transitions automatically to the normal SpO₂/HR Mode. To reenter proximity mode, the MODE register must be rewritten (even if the value is the same).

The proximity function can be disabled by resetting $PROX_INT_EN$ to 0. In this case, the SpO_2 or HR mode begins immediately.

High-Sensitivity Pulse Oximeter and Heart-Rate Sensor for Wearable Health

Register Maps and Descriptions

REGISTER	В7	В6	В5	B4	В3	B2	B1	В0	REG ADDR	POR STATE	R/W
STATUS	Į.										
Interrupt Status 1	A_FULL	PPG_ RDY	ALC_ OVF	PROX_ INT				PWR_ RDY	0x00	0X00	R
Interrupt Status 2							DIE_TEMP _RDY		0x01	0x00	R
Interrupt Enable 1	A_FULL_ EN	PPG_ RDY_EN	ALC_ OVF_EN	PROX_ INT_EN					0x02	0X00	R/W
Interrupt Enable 2					DIE_TEMP _RDY_EN					0x00	R/W
					FIFO						
FIFO Write Pointer					FIFO	D_WR_PTR[4	1:0]		0x04	0x00	R/W
Overflow Counter					OVF	_COUNTER[4:0]		0x05	0x00	R/W
FIFO Read Pointer					FIF	D_RD_PTR[4	l:0]		0x06	0x00	R/W
FIFO Data Register				FIFO_D	ATA[7:0]				0x07	0x00	R/W
CONFIGURATIO	N									•	
FIFO Configuration	SM	MP_AVE[2:0]	FIFO_ ROLL OVER_EN	ROLL FIFO_A_FULL[3:0]				0x08	0x00	R/W
Mode Configuration	SHDN	RESET					MODE[2:0]		0x09	0x00	R/W
SpO ₂ Configuration	0 (Reserved)	SPO2_A [1	DC_RGE :0]	S	PO2_SR[2:0)]	LED_PW	/[1:0]	0x0A	0x00	R/W
RESERVED									0x0B	0x00	R/W
LED Pulse				LED1_	PA[7:0]				0x0C	0x00	R/W
Amplitude				LED2_	PA[7:0]				0x0D	0x00	R/W
RESERVED										0x00	R/W
RESERVED										0x00	R/W
Proximity Mode LED Pulse Amplitude		PILOT_PA[7:0]							0x10	0x00	R/W
Multi-LED			SLOT2[2:0)]			SLOT1[2:0]		0x11	0x00	R/W
Mode Control Registers			SLOT4[2:0)]			SLOT3[2:0]		0x12	0x00	R/W

Register Maps and Descriptions (continued)

REGISTER	В7	В6	В5	B4	В3	B2	B1	В0	REG ADDR	POR STATE	R/W
RESERVED									0x13- 0x17	0xFF	R/W
RESERVED		0x18- 0x1E	0x00	R							
DIE TEMPERATI	JRE										
Die Temp Integer				TINT	[7:0]				0x1F	0x00	R
Die Temp Fraction						TFRAG	C[3:0]		0x20	0x00	R
Die Temperature Config								TEMP _EN	0x21	0x00	R
RESERVED									0x22- 0x2F	0x00	R/W
PROXIMITY FUN	ICTION										
Proximity Interrupt Threshold	PROX_INT_THRESH[7:0]								0x30	0x00	R/W
PART ID											
Revision ID				REV_I	ID[7:0]				0xFE	0xXX*	R
Part ID				PART	_ID[7]				0xFF	0x15	R

^{*}XX denotes a 2-digit hexadecimal number (00 to FF) for part revision identification. Contact Maxim Integrated for the revision ID number assigned for your product.

Interrupt Status (0x00-0x01)

REGISTER	В7	В6	B5	B4	В3	B2	B1	В0	REG ADDR	POR STATE	R/W
Interrupt Status 1	A_FULL	PPG_RDY	ALC_OVF	PROX_ INT				PWR_ RDY	0x00	0X00	R
Interrupt Status 2							DIE_ TEMP_RDY		0x01	0x00	R

Whenever an interrupt is triggered, the MAX30102 pulls the active-low interrupt pin into its low state until the interrupt is cleared.

A_FULL: FIFO Almost Full Flag

In SpO2 and HR modes, this interrupt triggers when the FIFO write pointer has a certain number of free spaces remaining. The trigger number can be set by the FIFO_A_FULL[3:0] register. The interrupt is cleared by reading the Interrupt Status 1 register (0x00).

PPG_RDY: New FIFO Data Ready

In SpO2 and HR modes, this interrupt triggers when there is a new sample in the data FIFO. The interrupt is cleared by reading the Interrupt Status 1 register (0x00), or by reading the FIFO_DATA register.

ALC_OVF: Ambient Light Cancellation Overflow

This interrupt triggers when the ambient light cancellation function of the SpO_2/HR photodiode has reached its maximum limit, and therefore, ambient light is affecting the output of the ADC. The interrupt is cleared by reading the Interrupt Status 1 register (0x00).

PROX_INT: Proximity Threshold Triggered

The proximity interrupt is triggered when the proximity threshold is reached, and SpO_2/HR mode has begun. This lets the host processor know to begin running the SpO_2/HR algorithm and collect data. The interrupt is cleared by reading the Interrupt Status 1 register (0x00).

PWR_RDY: Power Ready Flag

On power-up or after a brownout condition, when the supply voltage V_{DD} transitions from below the undervoltage lockout (UVLO) voltage to above the UVLO voltage, a power-ready interrupt is triggered to signal that the module is powered-up and ready to collect data.

DIE_TEMP_RDY: Internal Temperature Ready Flag

When an internal die temperature conversion is finished, this interrupt is triggered so the processor can read the temperature data registers. The interrupt is cleared by reading either the Interrupt Status 2 register (0x01) or the TFRAC register (0x20).

High-Sensitivity Pulse Oximeter and Heart-Rate Sensor for Wearable Health

The interrupts are cleared whenever the interrupt status register is read, or when the register that triggered the interrupt is read. For example, if the SpO2 sensor triggers an interrupt due to finishing a conversion, reading either the FIFO data register or the interrupt register clears the interrupt pin (which returns to its normal HIGH state). This also clears all the bits in the interrupt status register to zero.

Interrupt Enable (0x02-0x03)

REGISTER	В7	В6	B5	B4	В3	B2	B1	В0	REG ADDR	POR STATE	R/W
Interrupt Enable 1	A_ FULL_ EN	PPG_ RDY_EN	ALC_ OVF_EN	PROX_ INT_EN					0x02	0X00	R/W
Interrupt Enable 2							DIE_TEMP_ RDY_EN		0x03	0x00	R/W

Each source of hardware interrupt, with the exception of power ready, can be disabled in a software register within the MAX30102 IC. The power-ready interrupt cannot be disabled because the digital state of the module is reset upon a brownout condition (low power supply voltage), and the default condition is that all the interrupts are disabled. Also, it is important for the system to know that a brownout condition has occurred, and the data within the module is reset as a result.

The unused bits should always be set to zero for normal operation.

FIFO (0x04-0x07)

REGISTER	B7	В6	B5	B4	ВЗ	B2	B1	В0	REG ADDR	POR STATE	R/W
FIFO Write Pointer					F	0x04	0x00	R/W			
Over Flow Counter					OVF_COUNTER[4:0]						R/W
FIFO Read Pointer					FIFO_RD_PTR[4:0]						R/W
FIFO Data Register				FIFO_D	FIFO_DATA[7:0]						R/W

FIFO Write Pointer

The FIFO Write Pointer points to the location where the MAX30102 writes the next sample. This pointer advances for each sample pushed on to the FIFO. It can also be changed through the I²C interface when MODE[2:0] is 010, 011, or 111.

FIFO Overflow Counter

When the FIFO is full, samples are not pushed on to the FIFO, samples are lost. OVF_COUNTER counts the number of samples lost. It saturates at 0xF. When a complete sample is "popped" (i.e., removal of old FIFO data and shifting the samples down) from the FIFO (when the read pointer advances), OVF_COUNTER is reset to zero.

FIFO Read Pointer

The FIFO Read Pointer points to the location from where the processor gets the next sample from the FIFO through the I²C interface. This advances each time a sample is popped from the FIFO. The processor can also write to this pointer after reading the samples to allow rereading samples from the FIFO if there is a data communication error.

FIFO Data Register

The circular FIFO depth is 32 and can hold up to 32 samples of data. The sample size depends on the number of LED channels (a.k.a. channels) configured as active. As each channel signal is stored as a 3-byte data signal, the FIFO width can be 3 bytes or 6 bytes in size.

The FIFO_DATA register in the I²C register map points to the next sample to be read from the FIFO. FIFO_RD_PTR points to this sample. Reading FIFO_DATA register, does not automatically increment the I²C register address. Burst reading this register, reads the same address over and over. Each sample is 3 bytes of data per channel (i.e., 3 bytes for RED, 3 bytes for IR, etc.).

The FIFO registers (0x04–0x07) can all be written and read, but in practice only the FIFO_RD_PTR register should be written to in operation. The others are automatically incremented or filled with data by the MAX30102. When starting a new SpO₂ or heart rate conversion, it is recommended to first clear the FIFO_WR_PTR, OVF_COUNTER, and FIFO_RD_PTR registers to all zeroes (0x00) to ensure the FIFO is empty and in a known state. When reading the MAX30102 registers in one burst-read I2C transaction, the register address pointer typically increments so that the next byte of data sent is from the next register, etc. The exception to this is the FIFO data register, register 0x07. When reading this register, the address pointer does not increment, but the FIFO_RD_PTR does. So the next byte of data sent represents the next byte of data available in the FIFO.

Entering and exiting the proximity mode (when PROX_INT_EN = 1) clears the FIFO by setting the write and read pointers equal to each other.

Reading from the FIFO

Normally, reading registers from the I²C interface autoincrements the register address pointer, so that all the registers can be read in a burst read without an I²C start event. In the MAX30102, this holds true for all registers except for the FIFO_DATA register (register 0x07).

Reading the FIFO_DATA register does not automatically increment the register address. Burst reading this register reads data from the same address over and over. Each sample comprises multiple bytes of data, so multiple bytes should be read from this register (in the same transaction) to get one full sample.

The other exception is 0xFF. Reading more bytes after the 0xFF register does not advance the address pointer back to 0x00, and the data read is not meaningful.

FIFO Data Structure

The data FIFO consists of a 32-sample memory bank that can store IR and Red ADC data. Since each sample consists of two channels of data, there are 6 bytes of data for each sample, and therefore 192 total bytes of data can be stored in the FIFO.

The FIFO data is left-justified as shown in <u>Table 1</u>; in other words, the MSB bit is always in the bit 17 data position regardless of ADC resolution setting. See Table 2 for a visual presentation of the FIFO data structure.

Table 1. FIFO Data is Left-Justified

ADC Resolution	FIFO_DATA[17]	FIFO_DATA[16]	:	FIFO_DATA[12]	FIFO_DATA[11]	FIFO_DATA[10]	FIFO_DATA[9]	FIFO_DATA[8]	FIFO_DATA[7]	FIFO_DATA[6]	FIFO_DATA[5]	FIFO_DATA[4]	FIFO_DATA[3]	FIFO_DATA[2]	FIFO_DATA[1]	FIFO_DATA[0]
18-bit																
17-bit																
16-bit																
15-bit																

FIFO Data Contains 3 Bytes per Channel

The FIFO data is left-justified, meaning that the MSB is always in the same location regardless of the ADC resolution setting. FIFO DATA[18] – [23] are not used. Table 2 shows the structure of each triplet of bytes (containing the 18-bit ADC data output of each channel).

Each data sample in SpO₂ mode comprises two data triplets (3 bytes each), To read one sample, requires an I²C read command for each byte. Thus, to read one sample in SpO₂ mode, requires 6 I²C byte reads. The FIFO read pointer is automatically incremented after the first byte of each sample is read.

Write/Read Pointers

Write/Read pointers are used to control the flow of data in the FIFO. The write pointer increments every time a new sample is added to the FIFO. The read pointer is incremented every time a sample is read from the FIFO. To reread a sample from the FIFO, decrement its value by one and read the data register again.

The FIFO write/read pointers should be cleared (back to 0x00) upon entering SpO₂ mode or HR mode, so that there is no old data represented in the FIFO. The pointers are automatically cleared if V_{DD} is power-cycled or V_{DD} drops below its UVLO voltage.

Table 2. FIFO Data (3 Bytes per Channel)
--

BYTE 1							FIFO_ DATA[17]	FIFO_ DATA[16]
BYTE 2	FIFO_	FIFO_						
	DATA[15]	DATA[14]	DATA[13]	DATA[12]	DATA[11]	DATA[10]	DATA[9]	DATA[8]
BYTE 3	FIFO_	FIFO_						
	DATA[7]	DATA[6]	DATA[5]	DATA[4]	DATA[3]	DATA[2]	DATA[1]	DATA[0]

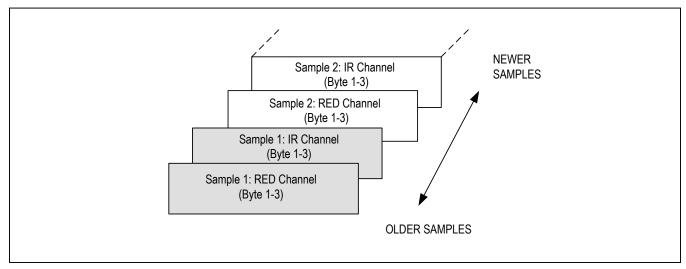


Figure 2. Graphical Representation of the FIFO Data Register. It shows IR and Red in SpO₂ Mode.

Pseudo-Code Example of Reading Data from FIFO

```
First transaction: Get the FIFO_WR_PTR:
START;
Send device address + write mode
Send address of FIFO WR PTR;
REPEATED_START;
Send device address + read mode
Read FIFO WR PTR;
STOP;
The central processor evaluates the number of samples to be read from the FIFO:
NUM AVAILABLE SAMPLES = FIFO WR PTR - FIFO RD PTR
(Note: pointer wrap around should be taken into account)
NUM SAMPLES TO READ = < less than or equal to NUM AVAILABLE SAMPLES >
Second transaction: Read NUM SAMPLES TO READ samples from the FIFO:
START;
Send device address + write mode
Send address of FIFO DATA;
REPEATED START;
Send device address + read mode
for (i = 0; i < NUM SAMPLES TO READ; i++) {
Read FIFO DATA;
Save LED1[23:16];
Read FIFO DATA;
Save LED1[15:8];
Read FIFO DATA;
Save LED1[7:0];
Read FIFO DATA;
Save LED2[23:16];
Read FIFO DATA;
Save LED2[15:8];
Read FIFO DATA;
Save LED2[7:0];
Read FIFO DATA;
}
STOP;
START;
Send device address + write mode
Send address of FIFO RD PTR;
Write FIFO RD PTR;
STOP;
```

Third transaction: Write to FIFO_RD_PTR register. If the second transaction was successful, FIFO_RD_PTR points to the next sample in the FIFO, and this third transaction is not necessary. Otherwise, the processor updates the FIFO_RD_PTR appropriately, so that the samples are reread.

FIFO Configuration (0x08)

REGISTE	R	В7	В6	В5	B4	В3	B2	B1	В0	REG ADDR	POR STATE	R/W
FIFO Configurat	on	5	SMP_AVE[2:	0]	FIFO_ROL LOVER_EN	FIFO_A_FULL[3:0]			0x08	0x00	R/W	

Bits 7:5: Sample Averaging (SMP_AVE)

To reduce the amount of data throughput, adjacent samples (in each individual channel) can be averaged and decimated on the chip by setting this register.

Table 3. Sample Averaging

SMP_AVE[2:0]	NO. OF SAMPLES AVERAGED PER FIFO SAMPLE
000	1 (no averaging)
001	2
010	4
011	8
100	16
101	32
110	32
111	32

Bit 4: FIFO Rolls on Full (FIFO_ROLLOVER_EN)

This bit controls the behavior of the FIFO when the FIFO becomes completely filled with data. If FIFO_ROLLOVER_EN is set (1), the FIFO address rolls over to zero and the FIFO continues to fill with new data. If the bit is not set (0), then the FIFO is not updated until FIFO_DATA is read or the WRITE/READ pointer positions are changed.

Bits 3:0: FIFO Almost Full Value (FIFO_A_FULL)

This register sets the number of data samples (3 bytes/sample) remaining in the FIFO when the interrupt is issued. For example, if this field is set to 0x0, the interrupt is issued when there is 0 data samples remaining in the FIFO (all 32 FIFO words have unread data). Furthermore, if this field is set to 0xF, the interrupt is issued when 15 data samples are remaining in the FIFO (17 FIFO data samples have unread data).

FIFO_A_FULL[3:0]	EMPTY DATA SAMPLES IN FIFO WHEN INTERRUPT IS ISSUED	UNREAD DATA SAMPLES IN FIFO WHEN INTERRUPT IS ISSUED
0x0h	0	32
0x1h	1	31
0x2h	2	30
0x3h	3	29
0xFh	15	17

Mode Configuration [0x09]

REGISTER	В7	В6	B5	В4	В3	B2	B1	В0	REG ADDR	POR STATE	R/W
Mode Configuration	SHDN	RESET				MODE[2:0]		0x09	0x00	R/W	

Bit 7: Shutdown Control (SHDN)

The part can be put into a power-save mode by setting this bit to one. While in power-save mode, all registers retain their values, and write/read operations function as normal. All interrupts are cleared to zero in this mode.

Bit 6: Reset Control (RESET)

When the RESET bit is set to one, all configuration, threshold, and data registers are reset to their power-on-state through a power-on reset. The RESET bit is cleared automatically back to zero after the reset sequence is completed.

Note: Setting the RESET bit does not trigger a PWR RDY interrupt event.

Bits 2:0: Mode Control

These bits set the operating state of the MAX30102. Changing modes does not change any other setting, nor does it erase any previously stored data inside the data registers.

Table 4. Mode Control

MODE[2:0]	MODE	ACTIVE LED CHANNELS			
000	Do not use				
001	Do no	ot use			
010	Heart Rate mode	Red only			
011	SpO2 mode	Red and IR			
100–110	Do not use				
111	Multi-LED Mode	Red and IR			

SpO₂ Configuration (0x0A)

REGISTER	В7	В6	B5	B4	В3	B2	B1	В0	REG ADDR	POR STATE	R/W
SpO ₂ Configuration		SPO2_AD	C_RGE[1:0]	_RGE[1:0] SI		0]	LED_F	PW[1:0]	0x0A	0x00	R/W

Bits 6:5: SpO₂ ADC Range Control

This register sets the SpO₂ sensor ADC's full-scale range as shown in $\underline{\text{Table 5}}$.

Table 5. SpO₂ ADC Range Control (18-Bit Resolution)

SPO2_ADC_RGE[1:0]	LSB SIZE (pA)	FULL SCALE (nA)		
00	7.81	2048		
01	15.63	4096		
10	31.25	8192		
11	62.5	16384		

Bits 4:2: SpO₂ Sample Rate Control

These bits define the effective sampling rate with one sample consisting of one IR pulse/conversion and one Red pulse/conversion.

The sample rate and pulse width are related in that the sample rate sets an upper bound on the pulse width time. If the user selects a sample rate that is too high for the selected LED_PW setting, the highest possible sample rate is programmed instead into the register.

Table 6. SpO₂ Sample Rate Control

SPO2_SR[2:0]	SAMPLES PER SECOND
000	50
001	100
010	200
011	400
100	800
101	1000
110	1600
111	3200

See Table 11 and Table 12 for Pulse Width vs. Sample Rate information.

Bits 1:0: LED Pulse Width Control and ADC Resolution

These bits set the LED pulse width (the IR and Red have the same pulse width), and therefore, indirectly sets the integration time of the ADC in each sample. The ADC resolution is directly related to the integration time.

Table 7. LED Pulse Width Control

LED_PW[1:0]	PULSE WIDTH (μs)	ADC RESOLUTION (bits)		
00	69 (68.95)	15		
01	118 (117.78)	16		
10	215 (215.44)	17		
11	411 (410.75)	18		

LED Pulse Amplitude (0x0C-0x10)

REGISTER	В7	В6	B5	B4	В3	B2	B1	В0	REG ADDR	POR STATE	R/W
LED Pulse				LED1_	PA[7:0]				0x0C	0x00	R/W
Amplitude				LED2_	PA[7:0]				0x0D	0x00	R/W
RESERVED									0x0E	0x00	R/W
RESERVED									0x0F	0x00	R/W
Proximity Mode LED Pulse Amplitude		PILOT_PA[7:0]						0x10	0x00	R/W	

These bits set the current level of each LED as shown in Table 8.

Table 8. LED Current Control

LEDx_PA [7:0], RED_PA[7:0], or IR_PA[7:0]	TYPICAL LED CURRENT (mA)*
0x00h	0.0
0x01h	0.2
0x02h	0.4
0x0Fh	3.1
0x1Fh	6.4
0x3Fh	12.5
0x7Fh	25.4
0xFFh	50.0

^{*}Actual measured LED current for each part can vary widely due to the trimming methodology.

The purpose of PILOT_PA[7:0] is to set the LED power during the proximity mode, as well as in Multi-LED mode.

Multi-LED Mode Control Registers (0x11-0x12)

REGISTER	В7	В6	B5	В4	В3	B2	B1	В0	REG ADDR	POR STATE	R/W
Multi-LED Mode Control		SLOT2[2:0]				SLOT1[2:0]			0x11	0x00	R/W
Registers		SLOT4[2:0]				SLOT3[2:0]		0x12	0x00	R/W	

In multi-LED mode, each sample is split into up to four time slots, SLOT1 through SLOT4. These control registers determine which LED is active in each time slot, making for a very flexible configuration.

Table 9. Multi-LED Mode Control Registers

SLOTx[2:0] Setting	WHICH LED IS ACTIVE	LED PULSE AMPLITUDE SETTING
000	None (time slot is disabled)	N/A (Off)
001	LED1 (Red)	LED1_PA[7:0]
010	LED2 (IR)	LED2_PA[7:0]
011	None	N/A (Off)
100	None	N/A (Off)
101	LED1 (Red)	PILOT_PA[7:0]
110	LED2 (IR)	PILOT_PA[7:0]

Each slot generates a 3-byte output into the FIFO. One sample comprises all active slots, for example if SLOT1 and SLOT2 are non-zero, then one sample is $2 \times 3 = 6$ bytes.

The slots should be enabled in order (i.e., SLOT1 should not be disabled if SLOT2 is enabled).

Temperature Data (0x1F-0x21)

REGISTER	В7	В6	B5	B4	В3	B2	B1	В0	REG ADDR	POR STATE	R/W
Die Temp Integer	TINT[7]						0x1F	0x00	R		
Die Temp Fraction						TFRA	C[3:0]		0x20	0x00	R
Die Temperature Config								TEMP_EN	0x21	0x00	R

Temperature Integer

The on-board temperature ADC output is split into two registers, one to store the integer temperature and one to store the fraction. Both should be read when reading the temperature data, and the equation below shows how to add the two registers together:

This register stores the integer temperature data in 2's complement format, where each bit corresponds to 1°C.

Table 10. Temperature Integer

REGISTER VALUE (hex)	TEMPERATURE (°C)
0x00	0
0x01	+1
0x7E	+126
0x7F	+127
0x80	-128
0x81	-127
0xFE	-2
0xFF	-1

Temperature Fraction

This register stores the fractional temperature data in increments of 0.0625° C. If this fractional temperature is paired with a negative integer, it still adds as a positive fractional value (e.g., -128°C + 0.5°C = -127.5°C).

Temperature Enable (TEMP_EN)

This is a self-clearing bit which, when set, initiates a single temperature reading from the temperature sensor. This bit clears automatically back to zero at the conclusion of the temperature reading when the bit is set to one in IR or SpO₂ mode.

Proximity Mode Interrupt Threshold (0x30)

REGISTER	В7	В6	B5	B4	В3	B2	B1	В0	REG ADDR	POR STATE	R/W
Proximity Interrupt Threshold		PROX_INT_THRESH[7:0]						0x30	0x00	R/W	

This register sets the IR ADC count that will trigger the beginning of HR or SpO₂ mode. The threshold is defined as the 8 MSBs bits of the ADC count. For example, if PROX_INT_THRESH[7:0] = 0x01, then a 17-bit ADC value of 1023 (decimal) or higher triggers the PROX_INT interrupt. If PROX_INT_THRESH[7:0] = 0xFF, then only a saturated ADC triggers the interrupt.

Applications Information

Sample Rate and Performance

The maximum sample rate for the ADC depends on the selected pulse width, which in turn, determines the ADC resolution. For instance, if the pulse width is set to 69μ s then the ADC resolution is 15 bits, and all sample rates are selectable. However, if the pulse width is set to 411μ s, then the samples rates are limited. The allowed sample rates for both SpO₂ and HR Modes are summarized in the Table 11 and Table 12.

Power Considerations

The LED waveforms and their implication for power supply design are discussed in this section.

The LEDs in the MAX30102 are pulsed with a low duty cycle for power savings, and the pulsed currents can cause ripples in the V_{LED+} power supply. To ensure these pulses do not translate into optical noise at the LED outputs, the power supply must be designed to handle these. Ensure that the resistance and inductance from the power supply (battery, DC/DC converter, or LDO) to the pin is much smaller than 1Ω , and that there is at least $1\mu F$ of power supply bypass capacitance to a good ground plane. The capacitance should be located as close as physically possible to the IC.

Table 11. SpO₂ Mode (Allowed Settings)

CAMPLEC	PULSE WIDTH (μs)							
SAMPLES PER SECOND	69	118	215	411				
50	0	0	0	0				
100	0	0	0	0				
200	0	0	0	0				
400	0	0	0	0				
800	0	0	0					
1000	0	0						
1600	0							
3200								
Resolution (bits)	15	16	17	18				

Table 12. HR Mode (Allowed Settings)

CAMPI FO		PULSE W	IDTH (µs)	
SAMPLES PER SECOND	69	118	215	411
50	0	0	0	0
100	0	0	0	0
200	0	0	0	0
400	0	0	0	0
800	0	0	0	0
1000	0	0	0	0
1600	0	0	0	
3200	0			
Resolution (bits)	15	16	17	18

MAX30102

High-Sensitivity Pulse Oximeter and Heart-Rate Sensor for Wearable Health

In the Heart Rate mode, only the Red LED is used to capture optical data and determine the user's heart rate and/or photoplethysmogram (PPG).

SpO₂ Temperature Compensation

The MAX30102 has an accurate on-board temperature sensor that digitizes the IC's internal temperature upon command from the I²C master. The temperature has an effect on the wavelength of the red and IR LEDs. While the device output data is relatively insensitive to the wavelength of the IR LED, the red LED's wavelength is critical to correct interpretation of the data.

Table 13 shows the correlation of red LED wavelength versus the temperature of the LED. Since the LED die heats up with a very short thermal time constant (tens of microseconds), the LED wavelength should be calculated according to the current level of the LED and the temperature of the IC. Use Table 13 to estimate the temperature.

Red LED Current Settings vs. LED Temperature Rise

Add the temperature rise to the module temperature reading to estimate the LED temperature and output wavelength. The LED temperature estimate is valid even with very short pulse widths, due to the fast thermal time constant of the LED.

Interrupt Pin Functionality

The active-low interrupt pin pulls low when an interrupt is triggered. The pin is open-drain, which means it normally requires a pullup resistor or current source to an external voltage supply (up to +5V from GND). The interrupt pin is not designed to sink large currents, so the pullup resistor value should be large, such as $4.7k\Omega$.

Table 13. RED LED Current Settings vs. LED Temperature Rise

RED LED CURRENT SETTING	RED LED DUTY CYCLE (% OF LED PULSE WIDTH TO SAMPLE TIME)	ESTIMATED TEMPERATURE RISE (ADD TO TEMP SENSOR MEASUREMENT) (°C)
0001 (0.2mA)	8	0.1
1111 (50mA)	8	2
0001 (0.2mA)	16	0.3
1111 (50mA)	16	4
0001 (0.2mA)	32	0.6
1111 (50mA)	32	8

Timing for Measurements and Data Collection

Slot Timing in Multi-LED Modes

The MAX30102 can support two LED channels of sequential processing (Red and IR). Table 14 below displays the four possible channel slot times associated with each pulse width setting. Figure 3 shows an example of channel slot timing for a SpO_2 mode application with a 1kHz sample rate.

Table 14. Slot Timing

PULSE-WIDTH SETTING (μs)	CHANNEL SLOT TIMING (TIMING PERIOD BETWEEN PULSES) (µs)	CHANNEL-CHANNEL TIMING (RISING EDGE-TO-RISING EDGE) (µs)
69	358	427
118	407	525
215	505	720
411	696	1107

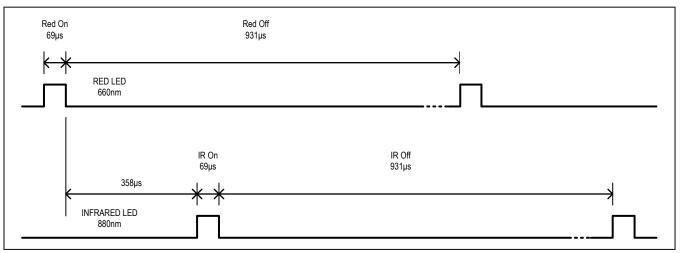


Figure 3. Channel Slot Timing for the SpO₂ Mode with a 1kHz Sample Rate